

1. Explain why electronic doping by introduction of suitable donor/acceptor levels in an amorphous material is difficult.
 - [1] concentration of defect states in the gap is higher than those introduced by doping
 - [2] Such low-coordination structure is so flexible
 - [3] VAPS make chalc glasses immune to doping because the Fermi is pinned
 - doping induces structural relaxation
 - free carriers that would be generated from dopants are now trapped
 - resistivity remains high (VAP)
2. Explain why the doping discussed in problem 1 might not improve carrier mobility.
 - [4] trapping at negative defect centers likely limits hole drift mobility
3. Would you expect to see blocking contacts in a metal-amorphous semiconductor contact? Explain your answer.
4. Describe the structural order giving rise to extended (delocalized) states and localized states in an amorphous semiconductor.
5. Provide definitions/explanations of the following:
 - Hubbard correlation energy
 - Localization length
 - Anderson transition
 - Localized “in the Anderson sense”
6. (a) What is the difference between variable range hopping and nearest neighbor hopping?
(b) In which type of conduction will tunneling occur?

References

- [1] J. Tauc, Amorphous semiconductors, *Physics Today* 29 (1976) 23–31. doi:10.1063/1.3024406.
URL <http://physicstoday.scitation.org/toc/pto/29/10>
- [2] J. Kim, H. Hiramatsu, H. Hosono, T. Kamiya, Effects of sulfur substitution in amorphous InGaZnO 4 : optical properties and first-principles calculations, *Journal of the Ceramic Society of Japan* 123 (7) (2015) 537–541. doi:10.2109/jcersj2.123.537.
- [3] H. Fritzsche, Why are chalcogenide glasses the materials of choice for Ovonic switching devices?, *Journal of Physics and Chemistry of Solids* 68 (2007) 878–882. doi:10.1016/j.jpcs.2007.01.017.

- [4] L. P. Kazakova, K. D. Tsendin, Controlling the U-center density in Se-As chalcogenide-glass semiconductors by doping with metals and halogens, *Semiconductors* 33 (7) (1999) 795–798.
doi:10.1134/1.1187784.
URL <https://link.springer.com/content/pdf/10.1134/1.1187784.pdf>